

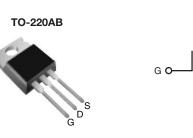
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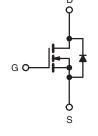
RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	100				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.27				
Q _g (Max.) (nC)	16				
Q _{gs} (nC)	4.4				
Q _{gd} (nC)	7.7				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF520PbF		
	SiHF520-E3		
SnPb	IRF520		
SIFD	SiHF520		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	100	v	
Gate-Source Voltage			V _{GS}	± 20		
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	L_	9.2		
	V _{GS} at 10 V	T _C = 100 °C	I _D	6.5	А	
Pulsed Drain Current ^a			I _{DM}	37		
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	200	mJ	
Repetitive Avalanche Current ^a			I _{AR}	9.2	Α	
Repetitive Avalanche Energy ^a			E _{AR}	6.0	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	60	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 3.5 mH, $R_g = 25 \Omega$, $I_{AS} = 9.2 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 9.2$ A, dI/dt ≤ 110 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62 - 2.5				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50				°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-						
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, U	Inless otherwi	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 2	250 μA	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to	o 25 °C,	$I_D = 1 \text{ mA}$	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{G}$	_{3S} , I _D = 2	250 µA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _{GS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero Gate Voltage Drain Current	lass	V _{DS} = 10	00 V, V _G	_S = 0 V	-	-	25	
Zero Gale Voltage Drain Gurrent	IDSS	$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$		$T_J = 150 \ ^\circ C$	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$ $I_D = 5.5 \text{ A}^{b}$		-	-	0.27	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}^{b}$		2.7	-	-	S	
Dynamic	-					_		
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$		-	360	-	pF	
Output Capacitance	C _{oss}	V _{DS} = 25 V,		-	150	-		
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	34	-		
Total Gate Charge	Qg				-	-	16	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 9.2 \text{ A}, V_{DS} = 80 \text{ V}$			-	-	4.4	nC
Gate-Drain Charge	Q _{gd}		see fig. 6 and 13 ^b		-	-	7.7	
Turn-On Delay Time	t _{d(on)}	V_{DD} = 50 V, I _D = 9.2 A, R _g = 18 Ω, R _D = 5.2 Ω, see fig. 10 ^b		-	8.8	-	ns	
Rise Time	t _r			-	30	-		
Turn-Off Delay Time	t _{d(off)}			-	19	-		
Fall Time	t _f			-	20	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9.2	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	37		
Body Diode Voltage	V _{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 9.2 \ A, \ V_{GS} = 0 \ V^b$		-	-	1.8	V	
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 9.2 A, dl/dt = 100 A/μs ^b		-	110	260	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.53	1.3	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn			-on is dor	minated b	y L _S and	L _D)

Notes

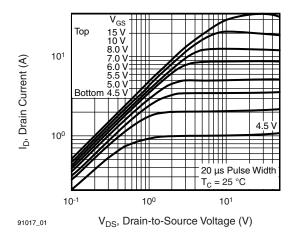
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

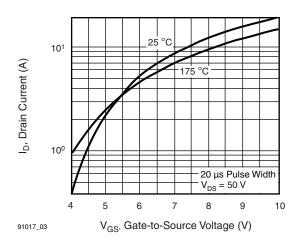


Fig. 3 - Typical Transfer Characteristics

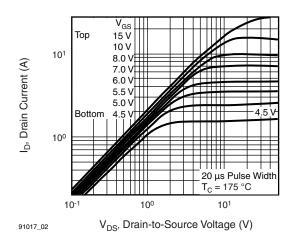


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

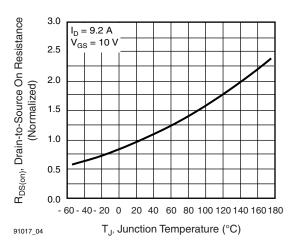
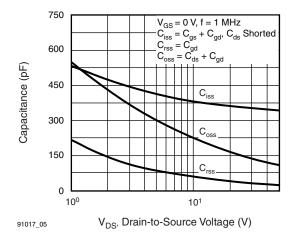
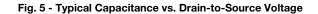


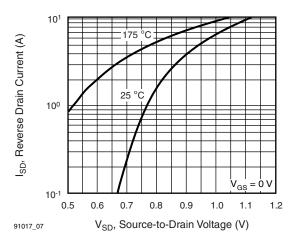
Fig. 4 - Normalized On-Resistance vs. Temperature

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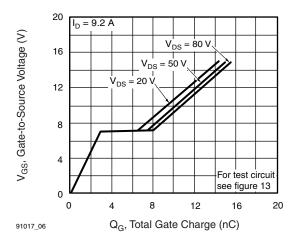


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

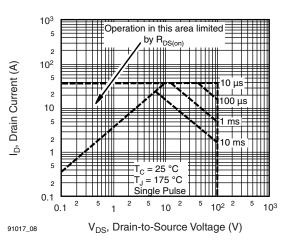
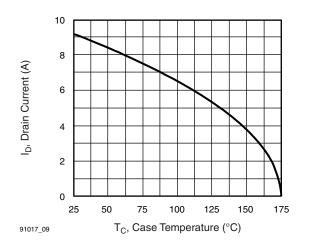


Fig. 8 - Maximum Safe Operating Area

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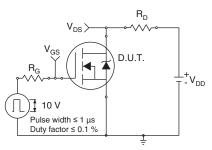


Fig. 10a - Switching Time Test Circuit

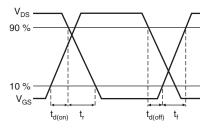


Fig. 9 - Maximum Drain Current vs. Case Temperature

Fig. 10b - Switching Time Waveforms

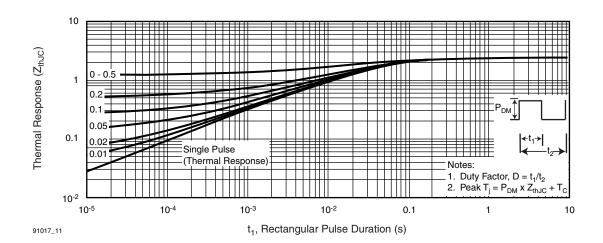


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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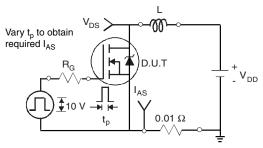


Fig. 12a - Unclamped Inductive Test Circuit

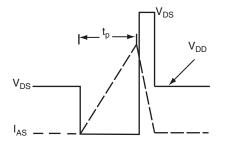


Fig. 12b - Unclamped Inductive Waveforms

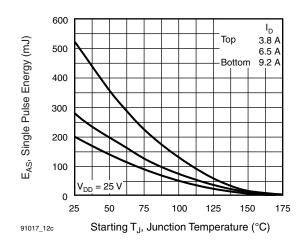


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

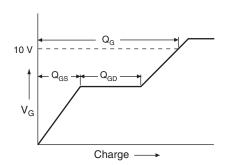


Fig. 13a - Basic Gate Charge Waveform

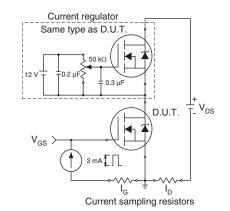
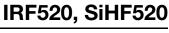


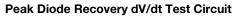
Fig. 13b - Gate Charge Test Circuit

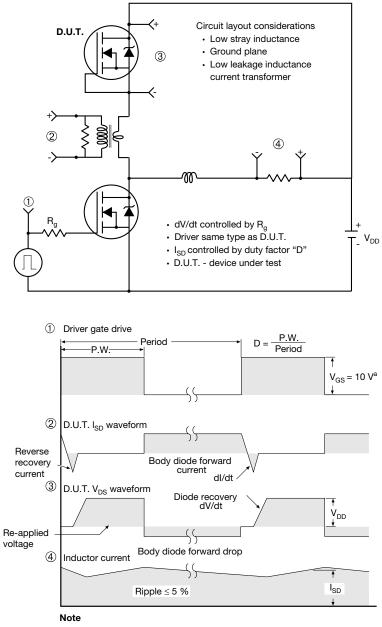
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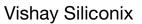
a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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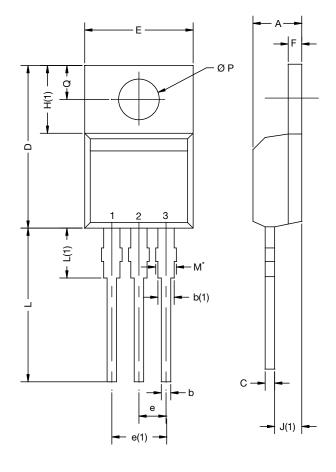
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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
ASE		Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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